# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

CUSTOMER



WEB: <a href="https://www.winstar.com.tw">https://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

### **SPECIFICATION**

MODULE NO.:	WH0802A-YGI	H-CT#
APPROVED BY:  ( FOR CUSTOMER USE ONLY )	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY		
		TAGE NO.	Modify	the	
G	2024/11/14		recommended	soldering	
			temperature		



MODLE NO:

華凌光電股份有限公司

### **RECORDS OF REVISION**

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.		SUMMARY	
0	2006/09/25		Fi	rst issue	
A	2011/09/13		Co	orrect ST7066IC	
			information		
В	2017/03/23		Remove IC information		
			Modify B/L information		
C	2019/08/27		M	odify Material List of	
			Co	omponents for RoHs	
D	2019/12/17		M	odify Precautions in use	
			of	LCD Modules	
E	2020/10/16		A	ld Interface	
F	2023/06/27		M	odify Backlight	
			In	formation(Note)	
G	2024/11/14		M	odify the recommended	
			SO	ldering temperature	

### **Contents**

- 1. Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9. Character Generator ROM Pattern
- 10.Reliability
- 11.Backlight Information
- 12.Inspection specification
- 13. Material List of Components for RoHs
- 14.Recommendable Storage

### 1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type:  $H\rightarrow$ Character Type,  $G\rightarrow$ Graphic Type,  $T\rightarrow$ TAB Type

③ Display Font: Character 08 words, 02 Lines.

Model serials no.

 $D\rightarrow EL$ , Green  $R\rightarrow LED$ , Red  $K\rightarrow DIP$  LED, White

 $W\rightarrow EL$ , White  $O\rightarrow LED$ , Orange  $E\rightarrow DIP$  LED, Yellow Green

 $M \rightarrow EL$ , Yellow Green  $G \rightarrow LED$ , Green  $H \rightarrow DIP$  LED, Amber  $F \rightarrow CCFL$ , White  $P \rightarrow LED$ , Blue  $I \rightarrow DIP$  LED, Red

 $Y \rightarrow LED$ , Yellow Green  $X \rightarrow LED$ , Dual color  $G \rightarrow LED$ , Green  $C \rightarrow LED$ , Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black G→STN Positive, Gray C→CSTN Negative, Black

Y→STN Positive, Yellow Green A→ASTN Negative, Black

L→Transmissive, W.T,12:00

② LCD Polarizer A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/D $\rightarrow$ Reflective, N.T, 12:00K $\rightarrow$ Transflective, W.T,12:00TemperatureG $\rightarrow$ Reflective, W. T, 6:00C $\rightarrow$ Transmissive, N.T,6:00

range/ View J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

direction B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

Special Code CT:English and Cyrillic standard font

E→Transflective, N.T.12:00

#:Fit in with the ROHS Directions and regulations

### 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

# **3.General Specification**

Item	Dimension	Unit				
Number of Characters	8 characters x 2Lines	_				
Module dimension	58.0 x 32.0 x 13.2 (MAX)	mm				
View area	38.0 x 16.0	mm				
Active area	27.81 x 11.5	mm				
Dot size	0.56 x 0.66	mm				
Dot pitch	0.60 x 0.70	mm				
Character size	2.96 x 5.56	mm				
Character pitch	3.55 x 5.94	mm				
LCD type	STN Positive, Gray Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on the same based o					
Duty	1/16					
View direction	6 o'clock					
Backlight Type	LED, Yellow Green					
IC	ST7066U					
Interface	68 series					

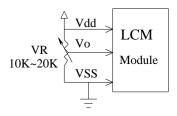
# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	VI	$V_{SS}$	_	$V_{ m DD}$	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	7	V
Supply Voltage For LCD	$V_{DD}$ - $V_{o}$	-0.3	_	13	V

# **5.Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.5	V
Supply Voltage For LCD	$ m V_{DD} ext{-}V_0$	Ta=25°C	4.2	4.35	4.5	V
* Note		Ta=70°C	3.5	_	_	V
Input High Volt.	$V_{ m IH}$	_	$0.7~\mathrm{V_{DD}}$	_	$V_{DD}$	V
Input Low Volt.	$V_{IL}$	_	Vss	_	0.6	V
Output High Volt.	$V_{\mathrm{OH}}$	_	3.9	_	V <sub>DD</sub>	V
Output Low Volt.	$V_{\mathrm{OL}}$	_	0	_	0.4	V
Supply Current	$I_{DD}$	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

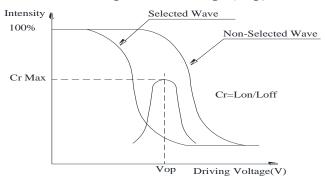
<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board



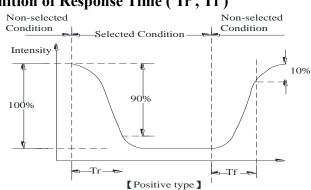
## **6.Optical Characteristics**

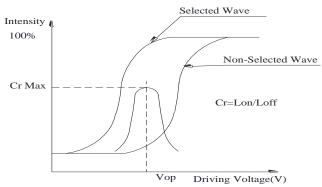
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
Vierry America	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	$\theta$		0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	_	150	200	ms
	T fall	_	_	150	200	ms

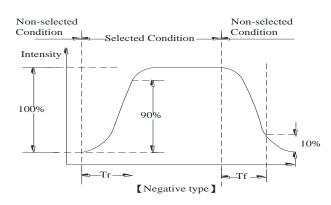
### **Definition of Operation Voltage (Vop)**



### Definition of Response Time (Tr, Tf)





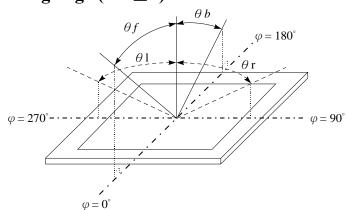


#### **Conditions:**

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Driving Waveform: 1/N duty, 1/a bias

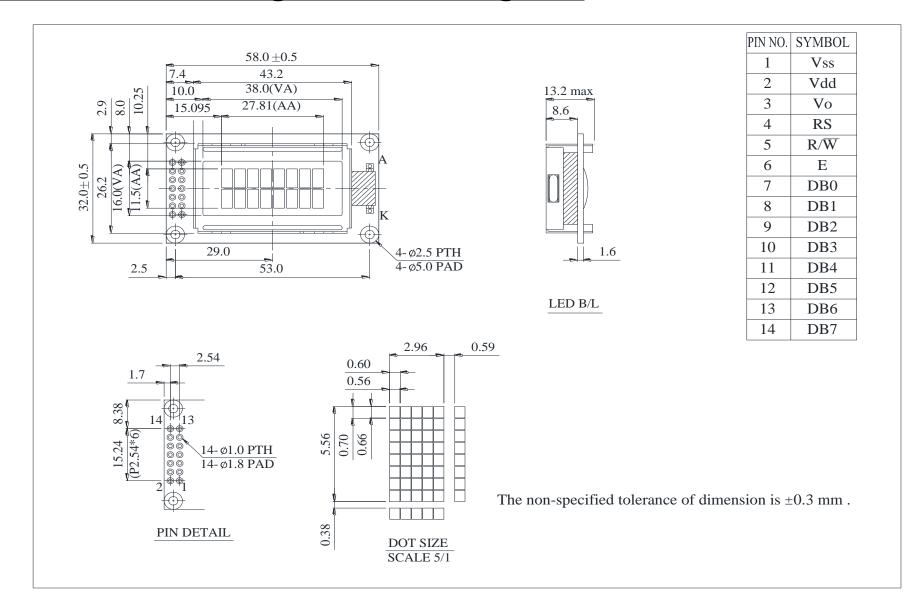
Definition of viewing angle  $(CR \ge 2)$ 

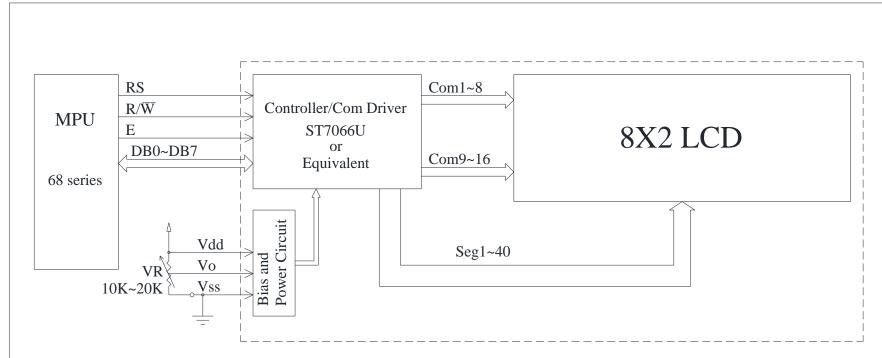


# **7.Interface Pin Function**

Pin No.	Symbol	Level	Description	
1	$V_{SS}$	0V	Ground	
2	$V_{DD}$	5.0V	Supply Voltage for logic	
3	VO	(Variable)	Operating voltage for LCD	
4	RS	H/L	H: DATA, L: Instruction code	
5	R/W	H/L	H: Read L: Write	
6	Е	Н,Н→L	Chip enable signal	
7	DB0	H/L	Data bus line	
8	DB1	H/L	Data bus line	
9	DB2	H/L	Data bus line	
10	DB3	H/L	Data bus line	
11	DB4	H/L	Data bus line	
12	DB5	H/L	Data bus line	
13	DB6	H/L	Data bus line	
14	DB7	H/L	Data bus line	

## **8.Contour Drawing & Block Diagram**





External contrast adjustment.

Character located DDRAM address DDRAM address

1 2 3 4 5 6 7 8 00 01 02 03 04 05 06 07 40 41 42 43 44 45 46 47

## 9.Character Generator ROM Pattern

Table.2

67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

## **10.Reliability**

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test								
Test Item	<b>Test Condition</b>	Not e						
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2					
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs						
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1					
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles						
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times						

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

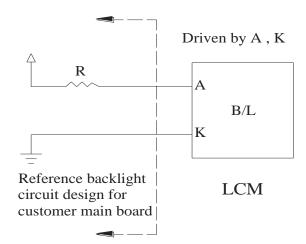
## **11.Backlight Information**

### **Specification**

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition		
Supply Current	ILED	63	70	84	mA	V=4.2V		
Supply Voltage	V	4.0	4.2	4.5	V	_		
Reverse Voltage	VR	_	_	8	V	_		
Luminance (Without LCD)	IV	165	190	_	cd/m <sup>2</sup>	ILED=70mA		
Wave Length	λр	568	572	575	nm	ILED=70mA		
Life Time	_	_	100000	_	Hr.	ILED≦70mA 25°C,50-60%RH		
Color	Yellow Green							

Note: A backlight driven by voltage will keep the drive current under the safe area (current between minimum and maximum).

If the B/L LED is driven by current only, the drive voltage cannot be considered as a reference value.



# **12.Inspection specification**

No	Item			Criterion		AQL
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect.  Missing character, dot or icon.  Display malfunction.  No function or no display.  Current consumption exceeds product specifications.  LCD viewing angle defect.  Mixed product types.  Contrast defect.			0.65	
02	Black or white spots on LCD (display only)	three white or bl	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>			2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As follow $\Phi = (x + y) / 2$ $X \longrightarrow Y$ $Y$ $Y$				2.5
		L	L≦2.5	$0.03 < W \le 0.05 \\ 0.05 < W$	As round type	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

No	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
	Chipped glass	Symbols Define:  x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:				
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	$x \leq 1/8a$		
06		$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a	2.5	
		Olf there are 2 or more 6.1.2 Corner crack:	chips, x is total length of	of each chip.		
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≤1/2t	Not over viewing area	x≤1/8a		
		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a		
		⊙ If there are 2 or more	chips, x is the total leng	gth of each chip.		

No	Item	Criterion A					
No 06	Glass	Symbols: x: Chip length k: Seal width L: Electrode pad let 6.2 Protrusion over 6.2.1 Chip on electr  y: Chip width y≤0.5mm 6.2.2 Non-conducti  y: Chip width y≤ L  OIf the chipped are remain and be inspected by the damaged. 6.2.3 Substrate prof	y: Chip width t: Glass thickr ngth terminal: rode pad:   x: Chip  x   x: Chip  x   at touches the ITe ected according to the heat sealed to the company of t	z: Chiness a: LC	terminal specifi mer, the alignm	Z  2.5  2.5  2.5  2.5  2.5  2.5	

No	Item	Criterion	AQL	
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5	
		8.1 Illumination source flickers when lit.	0.65	
0.0	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	2.5	
08	elements	LCD spot, lines and contamination standards.		
		8.3 Backlight doesn't light or color wrong.		
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5	
09	Bezel	stains or other contamination.		
		9.2 Bezel must comply with job specifications.	0.65	
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5	
		contamination.		
		10.2 COB seal surface may not have pinholes through to the IC.	2.5	
		10.3 The height of the COB should not exceed the height	0.65	
		indicated in the assembly diagram.		
		10.4 There may not be more than 2mm of sealant outside the seal	2.5	
		area on the PCB. And there should be no more than three places.		
	PCB、COB	10.5 No oxidation or contamination PCB terminals.		
		10.6 Parts on PCB must be the same as on the production	2.5	
10		characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65	
		10.7 The jumper on the PCB should conform to the product		
		characteristic chart.	0.65	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or		
		screw hold pad, make sure it is smoothed down.	2.5	
		10.9 The Scraping testing standard for Copper Coating of PCB		
		X	2.5	
		$\mathbf{Y}$ $\mathbf{X} * \mathbf{Y} \leq 2\mathbf{mm}^2$		
		11.1 No un-melted solder paste may be present on the PCB.	2.5	
		11.2 No cold solder joints, missing solder connections, oxidation		
11	Soldering	or icicle.		
		11.3 No residue or solder balls on PCB.	2.5	
		11.4 No short circuits in components on PCB.	0.65	

NO	Item	Criterion	
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
		must be present or look as if it cause the interface pin to sever.	
	General appearance	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

# **13.Material List of Components for**

### **RoHs**

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp							ppm			
Above limited value is set up according to RoHS.										

- 2. For RoHS compliance, the recommended soldering temperatures for different components are as follows:
- (1) FPC: 300°C, 1-3 seconds
- (2) Backlight AK and metal pin glass: 330°C, 1-5 seconds

Note: Customers should adjust the temperature and duration based on the actual materials used in their soldering process, including the soldering iron, solder paste, and any other components involved.

# 14.Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

dule Number:		I	Page: 1
<u>Panel Specification</u> :			
1. Panel Type:	Pass	☐ NG ,	
2. View Direction:	Pass	□ NG ,	
3. Numbers of Dots:	Pass	□ NG ,	
4. View Area:	Pass	□ NG ,	
5. Active Area:	Pass	□ NG ,	
6. Operating Temperature:	Pass	□ NG ,	
7. Storage Temperature:	Pass	□ NG ,	
8. Others:			
• Mechanical Specification :			
1. PCB Size:	Pass	□ NG ,	
2. Frame Size:	Pass	☐ NG ,	
3. Materal of Frame:	Pass	☐ NG ,	
4. Connector Position:	Pass	□ NG ,	
5. Fix Hole Position:	Pass	□ NG ,	
6. Backlight Position:	Pass	□ NG ,	
7. Thickness of PCB:	Pass	□ NG ,	
8. Height of Frame to PCB:	Pass	□ NG ,	
9. Height of Module:	Pass	□ NG ,	
10. Others:	Pass	□ NG ,	
Relative Hole Size:			
1. Pitch of Connector:	Pass	□ NG ,	
2. Hole size of Connector:	Pass	□ NG ,	
3. Mounting Hole size:	Pass	□ NG ,	
4. Mounting Hole Type:	Pass	□ NG ,	
5. Others:	Pass	□ NG ,	
· Backlight Specification:			
1. B/L Type:	☐ Pass	□ NG ,	
2. B/L Color:	Pass	□ NG ,	
3. B/L Driving Voltage (Refere	ence for LED		
4. B/L Driving Current:	Pass	□ NG ,	
5. Brightness of B/L:	Pass	□ NG ,	
6. B/L Solder Method:	Pass	□ NG ,	
7. Others:	☐ Pass	□ NG ,	



	winstar		
Modu	le Number :		Page: 2
<b>5</b> 、	<b>Electronic Characteristics of</b>	Module:	
1.	Input Voltage:	Pass	□ NG ,
2.	Supply Current:	Pass	□ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	Pass	□ NG ,
9.	ESD test:	Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	<b>Summary</b> :		
	Sales signature:		
	Customer Signature:		Date: / /